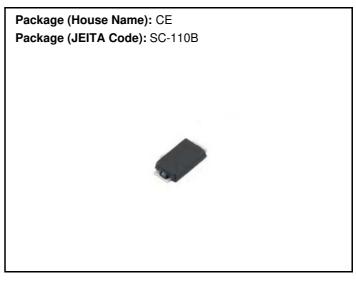
D3CE15ST

Schottky Barrier Diodes 150V, 3A

Feature

- Ultra-small SMD
- High Voltage
- Ultra thin PKG
- Tj=175°C
- Ultra low I_R
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE



Equivalent circuit

Absolute Maximum Ratings (unless otherwise specified : TI=25°C)

| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------|---------------------|--|------------|------|
| Storage temperrature | Tstg | | -55 to 175 | °C |
| Junction temperature | Tj | | -55 to 175 | °C |
| Repetitive peak reverse voltage | V _{RRM} | | 150 | V |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, TI=136°C | 3 | А |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C * | 1.7 | А |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=25°C * | 1.2 | A |
| Surge forward current | I _{FSM} | 50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=25°C | 80 | A |

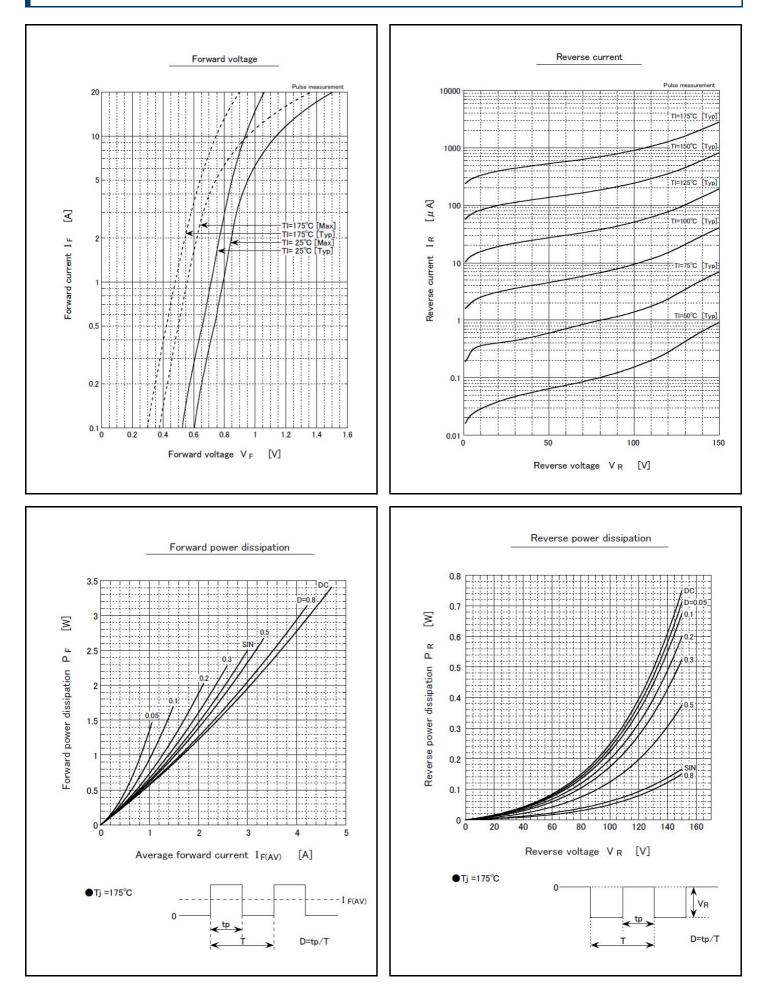
* : See the original Specifications

| Electrical Characteristics | (unless otherwise specified : TI=25°C) |
|-----------------------------------|--|
|-----------------------------------|--|

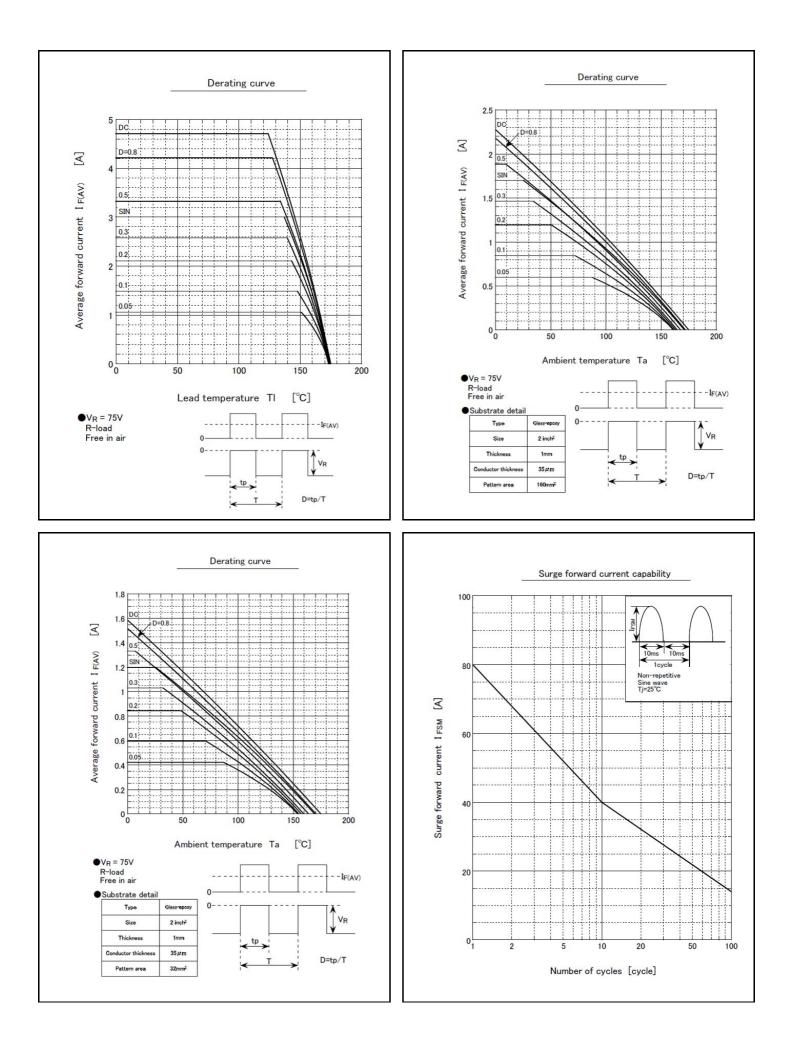
| Item | Symbol | Conditions | Ratings | | | Unit |
|--------------------|----------------|---|---------|-----|-------|------|
| | | | MIN | ТҮР | MAX | |
| Forward voltage | V _F | IF=3A, Pulse measurement | | | 0.88 | V |
| Reverse current | I _R | VR=150V, Pulse measurement | | | 0.008 | mA |
| Total capacitance | Ct | f=1MHz, VR=10V | | 52 | | pF |
| Thermal resistance | Rth(j-l) | Junction to lead | | | 15 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On glass-epoxy substrate * | | | 115 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On glass-epoxy substrate * | | | 172 | °C/W |

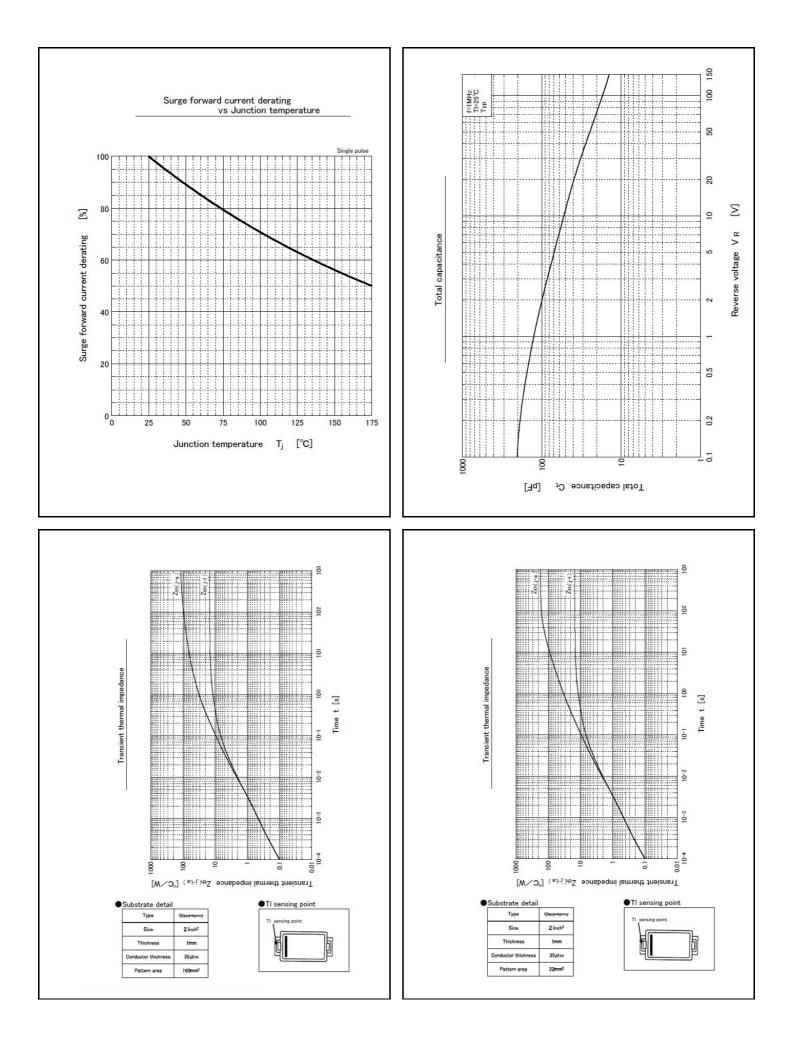
* : See the original Specifications

CHARACTERISTIC DIAGRAMS



3/7

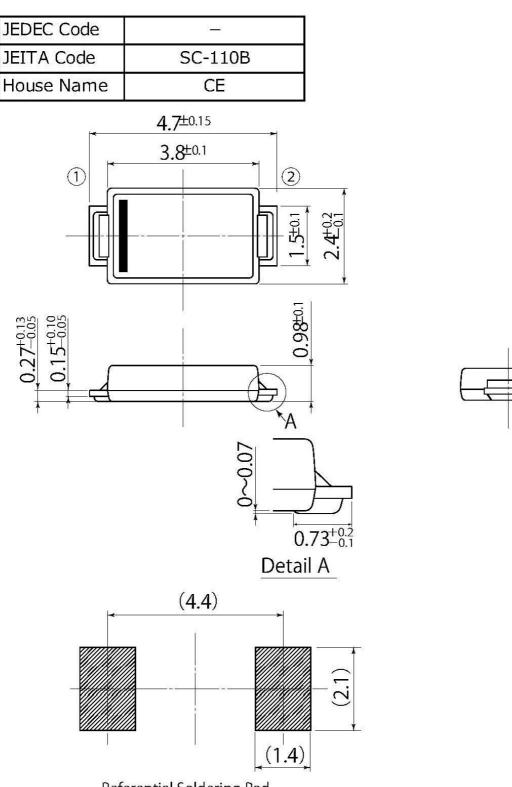




unit:mm

scale: 10/1

B5



Referential Soldering Pad

• Optimize soldering pad to the board design and soldering condition.

Notes

- 1. If you wish to use any such product, please be sure to refer to the specifications issued by Shindengen.
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[Special applications]

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[Specific applications]

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